

2329S-VB SOT23-3 Datasheet

P-Channel 100-V (D-S) MOSFET

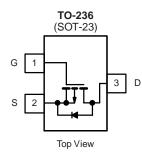
| PRODUCT SUMMARY | | | | | | |
|---------------------|-----------------------------------|--------------------|-----------------------|--|--|--|
| V _{DS} (V) | R _{DS(on)} (Ω) | I _D (A) | Q _g (Typ.) | | | |
| - 100 | 0.50 at V _{GS} = - 10 V | - 1.5 | 7.7 | | | |
| | 0.56 at V _{GS} = - 6.0 V | - 1.4 | 7.7 | | | |

FEATURES

- Halogen-free According to IEC 61249-2-21
 Available
- Trench Power MOSFET
- Ultra Low On-Resistance
- Small Size

APPLICATIONS

• Active Clamp Circuits in DC/DC Power Supplies



| ABSOLUTE MAXIMUM RATINGS | T _A = 25 °C, unle | ss otherwise r | noted | | |
|--|-----------------------------------|------------------|--------|--------------|------|
| Parameter | | Symbol | 5 s | Steady State | Unit |
| Drain-Source Voltage | | V _{DS} | - 100 | | V |
| Gate-Source Voltage | | V _{GS} | ± 20 | | |
| Continuous Durin Current (T. 450 °C) ^{a b} | T _A = 25 °C | - I _D | - 1.65 | - 1.5 | |
| Continuous Drain Current (T _J = 150 °C) ^{a, b} | T _A = 70 °C | | - 1.55 | - 1.4 | |
| Pulsed Drain Current | | I _{DM} | - 3.0 | | А |
| Continuous Source Current (Diode Conduction) ^{a, b} | | ۱ _S | - 1.4 | - 1.0 | |
| Single Pulse Avalanche Current | | I _{AS} | 4.5 | | |
| Single Pulse Avalanche Energy | L = 1.0 mH | E _{AS} | 1.01 | | mJ |
| Mariana Diata di a 8 h | T _A = 25 °C | P | 2.0 | 0.85 | W |
| Maximum Power Dissipation ^{a, b} | T _A = 70 °C | - P _D | 1.0 | 0.58 | |
| Operating Junction and Storage Temperature Ran | T _J , T _{stg} | - 55 | to 150 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|--|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| Mauinum lunation to Ambienta | t ≤ 5 s | R _{thJA} | 75 | 100 | | |
| Maximum Junction-to-Ambient ^a | Steady State | ' thJA | 120 | 166 | °C/W | |
| Maximum Junction-to-Foot (Drain) | Steady State | R _{thJF} | 40 | 50 | | |

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. Pulse width limited by maximum junction temperature.

HALOGEN

FREE Available



| | | | Limits | | | | |
|--|----------------------|--|-------------------------|------|-------|------|--|
| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 V, I_{D} = -250 \mu A$ | - 100 | | | V | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$ | - 1.0 | | - 3.0 | v | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V$, $V_{GS} = \pm 20 V$ | | | ± 100 | nA | |
| Zana Cata Maltana Duain Cumant | 1 | $V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$ | - 1 | | | | |
| Zero Gate Voltage Drain Current | IDSS | V_{DS} = - 100 V, V_{GS} = 0 V, T_{J} = 55 °C | | | - 10 | μA | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \le$ - 15 V, V_{GS} = 10 V | - 1.6 | | | А | |
| | D | V _{GS} = - 10 V, I _D = - 0.5 A | | 0.50 | | Ω | |
| Drain-Source On-Resistance ^a | R _{DS(on)} | V _{GS} = - 6.0 V, I _D = - 0.5 A | | 0.56 | | | |
| Forward Transconductance ^a | 9 _{fs} | $V_{DS} = -15 \text{ V}, \text{ I}_{D} = -0.5 \text{ A}$ | | 2.2 | | S | |
| Diode Forward Voltage | V _{SD} | $I_{S} = -1.0 \text{ A}, V_{GS} = 0 \text{ V}$ | | 0.7 | - 1.2 | V | |
| Dynamic ^b | | | - | | | | |
| Total Gate Charge | Qg | V 50.V.V 10.V | | 7.7 | 12 | | |
| Gate-Source Charge | Q _{gs} | $V_{DS} = -50 \text{ V}, V_{GS} = 10 \text{ V},$ $I_{D} \cong -0.5 \text{ A}$ | | 1.5 | | nC | |
| Gate-Drain Charge | Q _{gd} | 1 <u>D</u> = - 0.0 A | | 2.5 | | | |
| Gate Resistance | R _g | f = 1.0 MHz | | 9 | | Ω | |
| Input Capacitance | C _{iss} | | | 520 | | | |
| Output Capacitance | C _{oss} | V_{DS} = - 25 V, V_{GS} = 0 V, f = 1 MHz | | 40 | | pF | |
| Reverse Transfer Capacitance | C _{rss} | | | 20 | | 1 | |
| Switching ^c | | | | | | | |
| Turn-On Time | t _{d(on)} | | | 7 | 11 | | |
| | t _r | V_{DD} = - 50 V, R _L = 75 Ω $I_D \cong$ - 1.0 A, V _{GEN} = - 10 V | | 11 | 17 | - ns | |
| Turn-Off Time | t _{d(off)} | $R_{g} = 6 \Omega$ | | 16 | 25 | | |
| | t _f | g = 0 00 | | 11 | 17 | | |
| Body Diode Reverse Recovery Charge Q _{rr} | | I _F = 0.5 A, dl/dt = 100 A/μs | dl/dt = 100 A/µs 90 135 | | | nC | |

Notes:

a. Pulse test: PW \leq 300 μs duty cycle \leq 2 %.

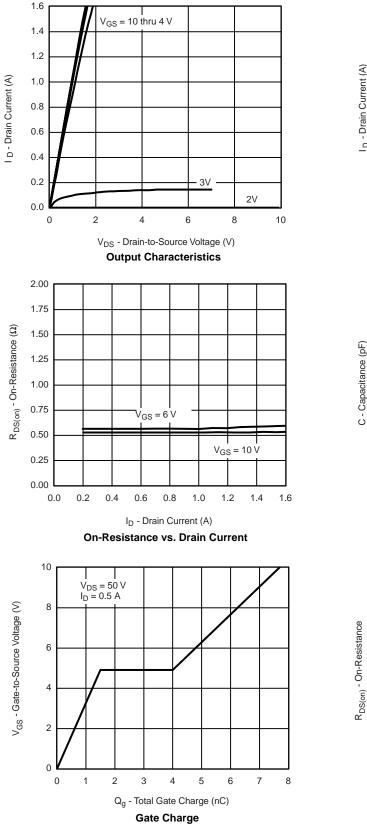
b. For DESIGN AID ONLY, not subject to production testing.

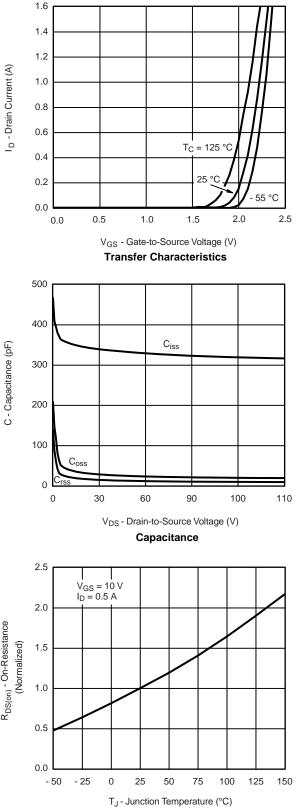
c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





On-Resistance vs. Junction Temperature

服务热线:400-655-8788



3.0 3 $I_{\rm D} = 0.5 ~\rm{A}$ 2.5 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - On-Resistance (Ω) . Т_Ј = 150 °С 1 Is - Source Current (A) 2.0 1.5 1.0 T_J = 25 °C 0.5 0.1 0.0 8 0 2 4 6 10 0 0.2 0.4 0.6 0.8 1.4 1.0 1.2 V_{SD} - Source-to-Drain Voltage (V) V_{GS} - Gate-to-Source Voltage (V) Source-Drain Diode Forward Voltage On-Resistance vs. Gate-to-Source Voltage 1.3 12 1.0 10 $I_D = 250 \ \mu A$ V_{GS(th)} Variance (V) 0.7 8 Power (W) 0.4 6 0.1 4 T_A = 25 °C - 0.2 2 - 0.5 0 - 50 - 25 0 25 50 75 85 95 100 0.01 0.1 10 100 600 1 T_J - Temperature (°C) Time (s) **Threshold Voltage** Single Pulse Power 10 I_{DM} Limited Limited by R_{DS(on)} 111 10 µs 1 100 µs I_D - Drain Current (A) ms 0.1 10 ms I_{D(on)} Limited 00 ms T_A = 25 °C 0.01 Single Pulse 10 s, 1 s 100 s, DC **BVDSS** Limited 0.001 10 100 1000 0.1 1

 $\label{eq:V_DS} V_{DS} \text{ - Drain-to-Source Voltage (V)} \\ ^* V_{GS} \text{ > minimum } V_{GS} \text{ at which } R_{DS(on)} \text{ is specified} \\ \textbf{Safe Operating Area} \\$

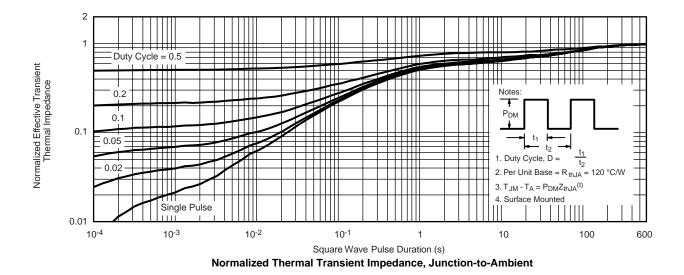
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)

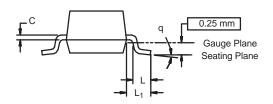




SOT-23 (TO-236): 3-LEAD







| Dim | MILLIM | IETERS | INCHES | | | |
|----------------|----------|--------|------------|---------|--|--|
| | Min | Max | Min | Max | | |
| Α | 0.89 | 1.12 | 0.035 | 0.044 | | |
| A ₁ | 0.01 | 0.10 | 0.0004 | 0.004 | | |
| A ₂ | 0.88 | 1.02 | 0.0346 | 0.040 | | |
| b | 0.35 | 0.50 | 0.014 | 0.020 | | |
| C | 0.085 | 0.18 | 0.003 | 0.007 | | |
| D | 2.80 | 3.04 | 0.110 | 0.120 | | |
| E | 2.10 | 2.64 | 0.083 | 0.104 | | |
| E ₁ | 1.20 | 1.40 | 0.047 | 0.055 | | |
| е | 0.95 BSC | | 0.0374 Ref | | | |
| e ₁ | 1.90 BSC | | 0.074 | 748 Ref | | |
| L | 0.40 | 0.60 | 0.016 | 0.024 | | |
| L ₁ | 0.64 Ref | | 0.025 | Ref | | |
| S | 0.50 Ref | | 0.020 Ref | | | |
| q | 3° | 8° | 3° | 8° | | |

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RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)



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